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<u>Diodes Incorporated</u> <u>MURS120-13-F</u>

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Datasheet of MURS120-13-F - DIODE GEN PURP 200V 1A SMB

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MURS120

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 40A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solder Plated Terminal Solderable per MIL-STD-202, Method 208 @3:
- Lead Free Plating (Matte Tin Finish).
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.093 grams (approximate)





Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	200	V
DC Blocking Voltage (Note 7) @ I _R = 5uA	V_R		
RMS Reverse Voltage	V _{R(RMS)}	141	V
Average Rectified Output Current @ T _T = 135°C	lo	1.0	Α
Non-Repetitive Peak Forward Surge Current8.3ms	l	40	^
Single Half Sine-Wave Superimposed on Rated Load	IFSM	IFSM 40	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Total Capacitance (Note 2)	Ст	27	pF
Typical Thermal Resistance, Junction to Terminal (Note 1)	$R_{ heta JT}$	15	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteris	tic	Symbol	Value	Unit
Forward Voltage	@ I _F = 1.0A, T _J = 25°C @ I _F = 1.0A, T _J = 150°C	V_{FM}	0.875 0.710	V
Peak Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 150°C	los.	2.0 50	μА
Reverse Recovery Time (Note 3)		t _{rr}	25	ns
Forward Recovery Time (Note 4)		t _{fr}	25	ns

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

 3. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

 4. Measured at 1.0MHz and applied reverse voltage of 4V DC.

 5. Measured with I_F = 0.5A, I_R = 1.0A, I_{Ir} = 0.25A. See Figure 5.

 6. Measured with I_F = 1.0A, di/dt = 100A/µs, Duty Cycle ≤ 2.0%.

- 7. Short duration pulse test used to minimize self-heating effect.

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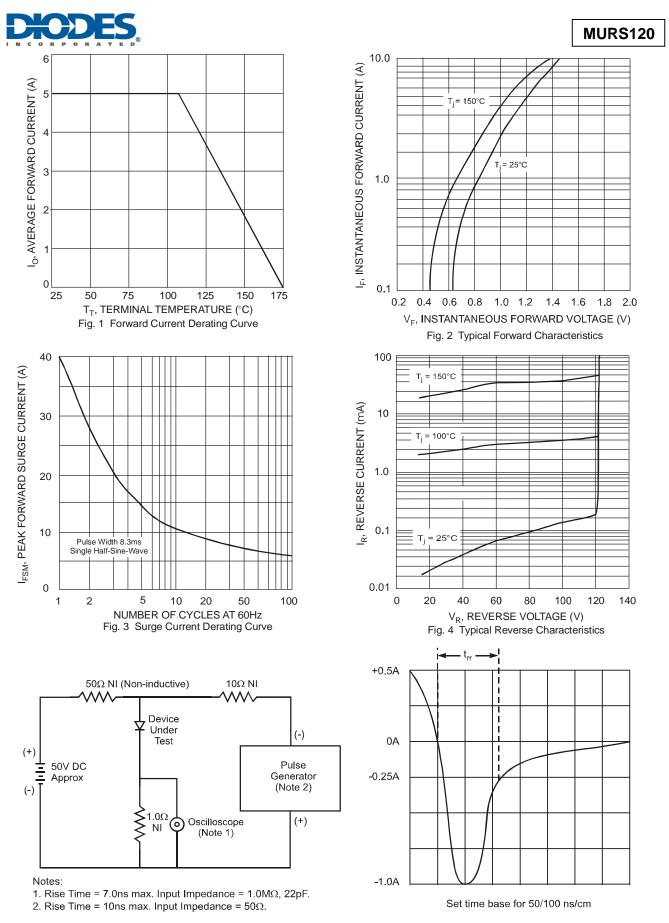


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

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Ordering Information (Note 7)

Part Number	Case	Packaging
MURS120 -13-F	SMB	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com.

Marking Information



U1DB = Product type marking code

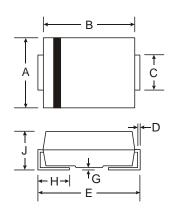
>|| = Manufacturers' code marking

YWW = Date code marking

Y = Last digit of year (ex: 2 for 2002)

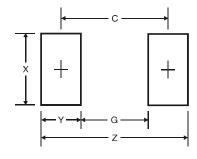
WW = Week code (01 - 53)

Package Outline Dimensions



SMB			
Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
C	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
G	0.05	0.20	
H	0.76	1.52	
J	2.00	2.50	
All Dimensions in mm			

Suggested Pad Layout



SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Υ	2.5
С	4.3



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